



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

David J. Corisis

Serial No.: 09/342,789

Filed: June 29, 1999

For: CHIP SCALE PACKAGE WITH
HEAT SPREADER AND METHOD OF
MANUFACTURE

Confirmation No.: 7096

Examiner: D. Graybill

Group Art Unit: 2822

Attorney Docket No.: 2269-3384.1US
(97-0564.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

July 5, 2005
Date


Signature

Leta M. Howard
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the Office Action of April 5, 2005 whose initial period of response is set to expire on July 5, 2005.

Amendments to the Title appear on page 3 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 4 of this paper.

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Amendments to the Drawings begin on page 10 of this paper and include an attached replacement drawing.

Remarks/Arguments begin on page 11 of this paper.

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IN THE TITLE:

The title has been amended herein. Pursuant to 37 C.F.R. §§ 1.121 and 1.125 (as amended to date), please enter the title as amended.

CHIP SCALE PACKAGE WITH HEAT SPREADER ~~AND METHOD OF MANUFACTURE~~